

ANUSHRUT JIGNASU

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EDUCATION

Iowa State University Ph.D. Student, Mechanical Engineering Co-Major: Computer Engineering	Expected: Spring 2026 GPA: 3.67/4.0
Iowa State University B.Sc. Mechanical Engineering Minor in Biomedical Engineering	Aug 2016 - May 2020 GPA: 3.5/4.0

RESEARCH INTERESTS

Neural Fields, Computer Vision and Graphics, Deep Learning, 3D Reconstruction, Computer Aided Design, Additive Manufacturing

SKILLS

Programming	Python, C++, C#, MATLAB, L ^A T _E X
Technologies	PyTorch, PyTorch Geometric, OpenCV, COLMAP, Unity, MCP
Tools	Linux, Blender, Solidworks, Autodesk Fusion 360, FreeCAD API

GRADUATE RESEARCH

Research Assistant in IDEA Lab | Iowa State University Aug 2021 - Ongoing

1. Large Language Models for G-code Debugging, Manipulation, and Comprehension

- Built **Slice-100K**, a large-scale multimodal dataset (100k+ samples) combining G-code text, 3D geometry, meshes, and renderings for training foundation models on additive manufacturing tasks.
- Fine-tuned **GPT-2** on 4 A100 GPUs using **SFT pipeline**, achieving 98% IoU on G-code translation tasks.
- Analyzed model failures to identify limits of token-level reasoning and geometric intent understanding.
- Prototyped **agentic CAD** tool integration via **FreeCAD MCP server** exposing parametric modeling APIs.

2. Topology-aware Neural Implicit Surface Reconstruction

- Designed an MLP-based framework for implicit surface reconstruction from noisy point cloud data.
- Integrated topological data analysis to achieve precise manifold mesh reconstruction.
- Explored the feasibility of neural radiance fields for multi-view 3D reconstruction and mesh extraction.

3. Conformal 3D Printing

- Designed a NURBS-based algorithm for Conformal 3D printing.
- Implemented a curved toolpath generation algorithm for non-planar material deposition.

4. Geometric Deep Learning for Manufacturability Analysis

- Applied Graph Neural Networks to 3D mesh representations for learning geometric and structural properties.

WORK EXPERIENCE

Autodesk, San Francisco, CA May 2025 - Aug 2025

Research Scientist Intern

- Led development of a pipeline from assembly parsing to contact-graph GNN inference for CAD completion.
- Built a contact-aware graph neural net (GATv2 + DGCNN); achieved +30% Top-1 over baselines.
- Implemented distributed data ingestion and training infrastructure for large-scale CAD assemblies.

Genies, Los Angeles, CA May 2024 - Aug 2024

Machine Learning Engineering Intern

- Developed algorithms for mesh deformation and alignment based on the SMPL model.
- Investigated differentiable methods for human pose and shape estimation.
- Optimized techniques to bypass the ground truth landmark requirement and achieve pose convergence.

- Designed and developed seven physical prototyping kits using a CNC machine, 3D printer, and laser cutter.
- Optimized material and manufacturing processes through trade studies, achieving a cost-effective design solution.
- Conducted detailed tolerance stack-up analyses and created precise engineering drawings using GD&T principles.

Smiths Medical (now ICU Medical), Minneapolis, MN

May 2019 - Aug 2019

- Engineered friction models that improved efficiency by 50% for infusion applications.
- Conducted physics-based simulations using MATLAB, Simulink, and micro-controller setups.
- Managed and revised CAD drawings for established infusion products.

PUBLICATIONS

1. A. Jignasu and D. Grandi. [Linkify: Learning from Interface-Augmented Assembly Graphs](#). *Under Review*.
2. A. Jignasu, K. O. Marshall, A. K. Mishra, L. N. Rillo, B. Ganapathysubramanian, A. Balu, C. Hegde, and A. Krishnamurthy. [Slice-100K: A Multimodal Dataset for Extrusion-based 3D Printing](#). *NeurIPS*, 2024
3. A. Jignasu, A. Balu, S. Sarkar, C. Hegde, B. Ganapathysubramanian, and A. Krishnamurthy. [SDFConnect: Neural Implicit Surface Reconstruction of a Sparse Point Cloud with Topological Constraints](#). *Deep Learning for Geometric Computing Workshop (DLGC), CVPR*, 2024
4. A. Jignasu, J. Rurup, E. Secor, and A. Krishnamurthy. [NURBS-based path planning for aerosol jet printing of conformal electronics](#). *Journal of Manufacturing Processes*, 2024
5. E. Herron, J. Rade, A. Jignasu, B. Ganapathysubramanian, A. Balu, S. Sarkar, and A. Krishnamurthy. [Latent Diffusion Models for Structural Component Design](#). *Computer-Aided Design*, 2024
6. A. Jignasu, K. O. Marshall, B. Ganapathysubramanian, A. Balu, C. Hegde, and A. Krishnamurthy. [Towards Foundational AI Models for Additive Manufacturing: Language Models for G-Code Debugging, Manipulation, and Comprehension](#). *arXiv preprint arXiv:2309.02465*, 2023
7. K. O. Marshall, M. Pham, A. Joshi, A. Jignasu, A. Balu, A. Krishnamurthy, and C. Hegde. [ZeroForge: Feedforward Text-to-Shape Without 3D Supervision](#). *arXiv preprint arXiv:2306.08183*, 2023
8. J. Rade, A. Jignasu, E. Herron, A. Corpuz, B. Ganapathysubramanian, S. Sarkar, A. Balu, and A. Krishnamurthy. [Deep learning-based 3D Multigrid Topology Optimization of Manufacturable Designs](#). *Engineering Applications of Artificial Intelligence*, 2023

TEACHING

1. “Mini course on 3D Vision”, Advanced Deep Learning Group, **TrAC, Iowa State University 2023**.

TALKS

1. “SDFConnect: Neural Implicit Surface Reconstruction of a Sparse Point Cloud with Topological Constraints.” Deep Learning for Geometric Computing (DLGC) Workshop, **CVPR 2024**.
2. “Evaluating Large Language Models for G-Code Debugging, Manipulation, and Comprehension.” IEEE International Workshop on LLM-Aided Design, **LAD 2024**.
3. “Deep Learning-based 3D Multigrid Topology Optimization of Manufacturable Designs.” Workshop on Scientific Machine Learning: Foundations and Applications, **TrAC, Iowa State University 2022**.
4. “Direct Fused Deposition Modeling (FDM) Additive Manufacturing of Voxelized CAD Models.” 16th U.S. National Congress on Computational Mechanics, **USNCCM 2021**.

SERVICE

1. Summer Geometry Initiative, **MIT, July 2023**.